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## **Amendments to the Claims:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

## **Listing of Claims:**

1-10 (Canceled)

- 11. (Currently Amended) A structure of an Electrically Erasable Programmable Read-Only Memory (EEPROM), comprising:
  - a silicon substrate having a source/drain region;
  - a tunnel oxide layer disposed over said silicon substrate;
  - a select gate disposed over said tunnel oxide layer, wherein said select gate is defined by a conductive layer covered with a first insulated material thereon and comprises a sidewall made of a second insulated material;
    - a single floating gate aligned to one side of said select gate;
  - a third insulated material contacted with said tunnel oxide layer and said floating gate and disposed over said select gate; and
    - a control gate formed on said third insulated material.
  - 12. (Original) The structure according to Claim 11, wherein each of said first insulated material, said second insulated material and said third insulated material is one selected from a group consisting of silicon oxide, silicon nitride and silicon oxide/nitride composite.
  - 13. (Original) The structure according to claim 11, wherein said conductive layer is one selected from a group consisting of polysilicon, amorphous silicon, recrystallized silicon and polycide.
  - 14. (Original) The structure according to claim 11, wherein each of said floating gate and said control gate is one selected from a group consisting of polysilicon, amorphous silicon and recrystallized silicon.
  - 15. (Currently Amended) A structure of an Electrically Erasable Programmable Read-Only Memory (EEPROM), comprising:
    - a silicon substrate having a source/drain region;

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a tunnel oxide layer disposed over said silicon substrate;

a select gate disposed over said tunnel oxide layer, wherein said select gate is defined by a conductive layer covered with a first insulated material thereon and comprises a sidewall made of a second insulated material;

a floating gate aligned to one side of said select gate;

a third insulated material contacted with said tunnel oxide layer and said floating gate <u>and disposed over</u> said select gate; and

a control gate formed on said third insulated material, wherein said control gate partially covers said third insulated material.